# **2SJ484**

## Silicon P-Channel MOS FET High Speed Power Switching

# HITACHI

ADE-208-501 A 2nd. Edition

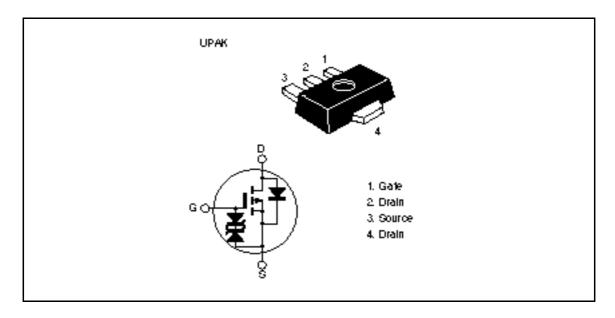
### **Features**

· Low on-resistance

$$R_{\mathrm{DS(on)}} = 0.18$$
 typ. (at  $V_{\mathrm{GS}} = -10\mathrm{V}, \, I_{\mathrm{D}} = -1\mathrm{A})$ 

- · Low drive current
- · High speed switching
- 4V gate drive devices.

### **Outline**





## **2SJ484**

### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit	
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	-30	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	-2	А	
Drain peak current	I <sub>D(pulse)</sub> *1	-4	А	
Body to drain diode reverse drain current	I <sub>DR</sub>	-2	А	
Channel dissipation	Pch*2	1	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW 100 µs, duty cycle 10 %

2. When using aluminium ceramic board (12.5 x 20 x 0.7 mm)

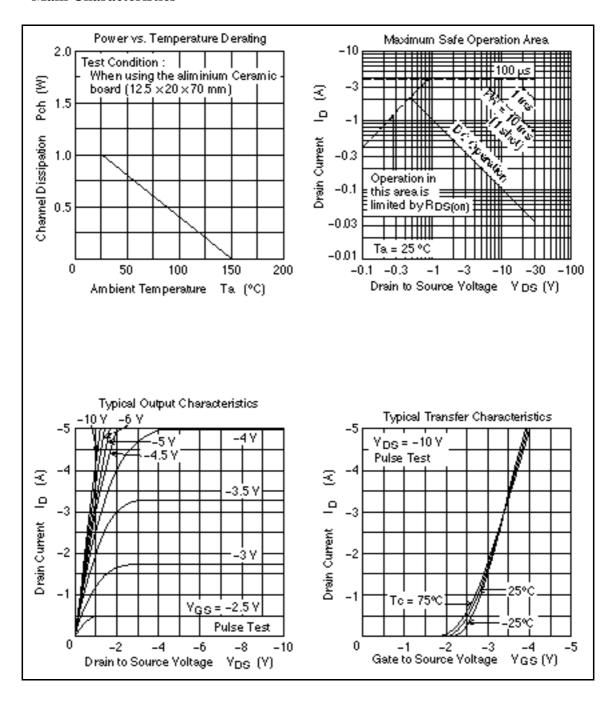
### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

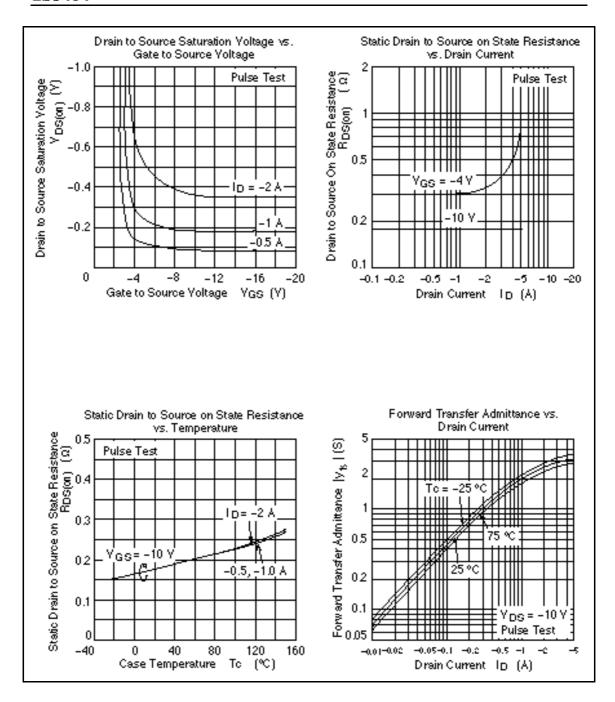
Item	Symbol	Min	Тур	Max	Unit	<b>Test Conditions</b>
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	_	_	V	$I_D = -10 \text{mA}, \ V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	-10	μΑ	$V_{DS} = -30 \text{ V}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	_	-2.0	V	$I_{D} = -1 \text{mA}, \ V_{DS} = -10 \text{V}$
Static drain to source on state resistance	$R_{\mathrm{DS(on)}}$	_	0.18	0.23		$I_{D} = -1A,$ $V_{GS} = -10V^{Note3}$
	R <sub>DS(on)</sub>	_	0.3	0.45		$I_D = -1A, V_{GS} = -4V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	1.2	2.0	_	S	$I_D = -1A, V_{DS} = -10V^{*1}$
Input capacitance	Ciss	_	230	_	pF	$V_{DS} = -10V$
Output capacitance	Coss	_	140	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	50	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	10	_	ns	$I_D = -1A, R_L = 30$
Rise time	t <sub>r</sub>	_	30	_	ns	$V_{GS} = -10V$
Turn-off delay time	$t_{d(off)}$	_	35	_	ns	_
Fall time	t <sub>f</sub>	_	30	_	ns	_
Body to drain diode forward voltage	$V_{DF}$	_	-0.95		V	$I_F = -2A, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	60	_	ns	$I_F = -2A, V_{GS} = 0$ diF/ dt = 50A/µs

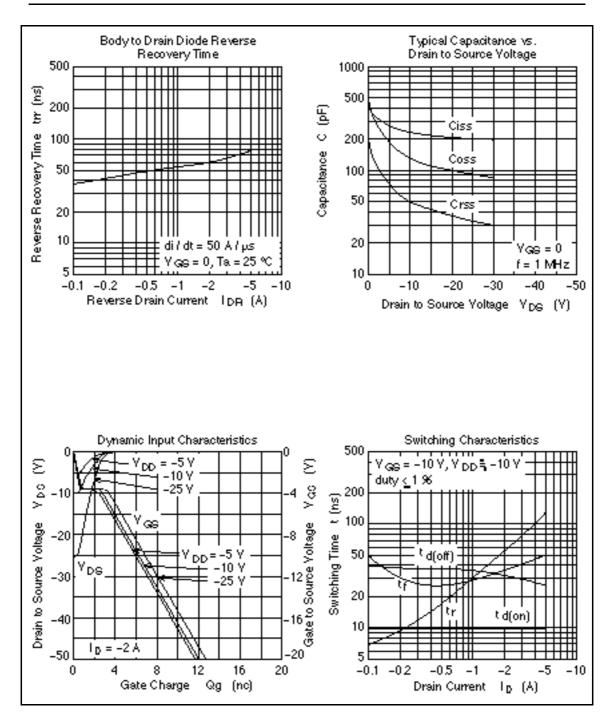
Notes: 1. Pulse test

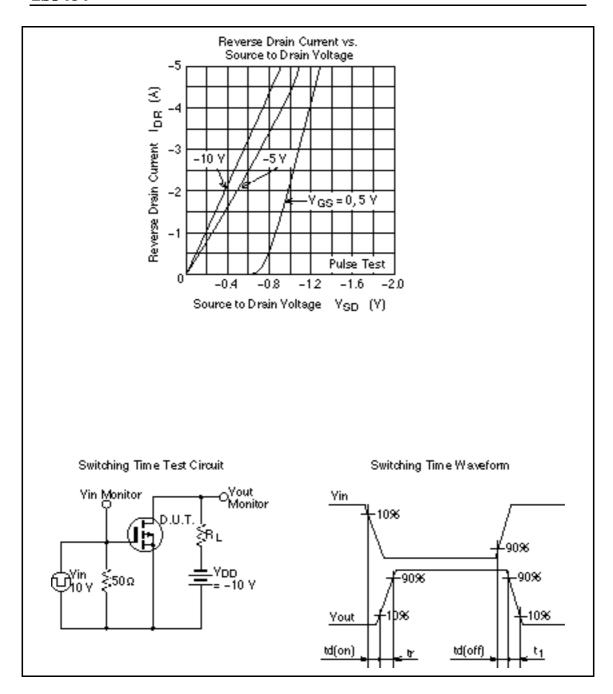
2. Marking is "WY".

### **Main Characteristics**



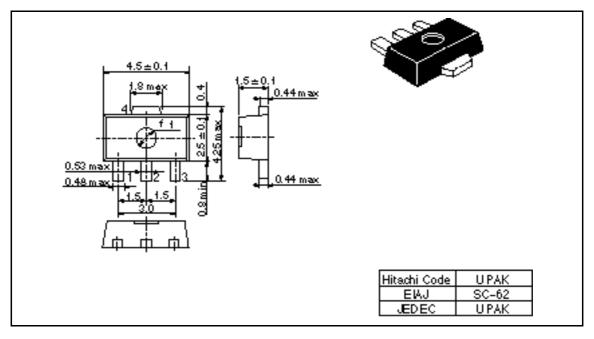






## **Package Dimensions**

Unit: mm



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